

IN THE CLAIMS:

1. A particle detection and removal system for wafer fabrication equipment, comprising:

a sample port for insertion in said wafer fabrication equipment;

a vacuum source having a vacuum port, wherein a diameter of said sample port is smaller than a diameter of said vacuum port; and

a particle sensor connected between said vacuum source and said sample port, said particle sensor for detecting a number of particles.

- 2. The system of claim 1, further comprising a modulated cleaning system for modulating a vacuum pressure between a first pressure state and a second pressure state.
- 3. The system of claim 2, wherein said first pressure state is provided by said vacuum source and the second pressure state is provided by a venturi boost.
- 4. The system of claim 2, wherein said modulated cleaning system comprises: a venturi boost connected between said vacuum source and said particle sensor for providing said second pressure state;
 - a first clean dry air (CDA) line;
 - a solenoid connected between said CDA line and said venturi boost;
- a controller box connected to said solenoid for controlling a modulation rate and duty cycle.
- 5. The system of claim 1, wherein said vacuum source comprises a house vacuum.
- 6. The system of claim 1, wherein said vacuum source comprises a portable hepa filter vacuum.

monitor.

- 7. The system of claim 1, further comprising a computing device connected to
- 8. The system of claim 1, wherein said computing device is a personal computer and monitor.

said particle monitor for displaying a count of particles detected by said particle



- 9. A particle detection and removal system for wafer fabrication equipment, comprising:
 - a portable cart;
 - a first vacuum hose for connection to a vacuum source;
- a second, smaller diameter, vacuum hose having a cleaning port for connection to the wafer fabrication equipment;
- a particle sensor for detecting a number of particles connected between said first vacuum hose and said second vacuum hose; and
- a display mechanism connected to said particle sensor for repeatedly displaying the number of particles detected.
- 10. The system of claim 9, wherein said second vacuum hose has an outside diameter on the order of ½ inch.
- 11. The system of claim 9, further comprising a modulated cleaning system for modulating a vacuum pressure in said second hose between a first pressure state and a second pressure state.
- 12. The system of claim 11, wherein said first pressure state is provided by said vacuum source.
- 13. The system of claim 11, wherein said modulated cleaning system comprises:
- a venturi boost connected to said first vacuum hose for providing said second pressure state;
 - a first clean dry air (CDA) line;
 - a solenoid connected between said CDA line and said venturi boost;
- a controller box connected to said solenoid for controlling a modulation rate and duty cycle.

- 14. The system of claim 13, further comprising a second CDA line, wherein said venturi boost provides both said first pressure state and said second pressure state.
- 15. The system of claim 9, wherein said display mechanism is a computer and monitor.
- 16. The system of claim 9, wherein said vacuum source comprises a house vacuum.
- 17. The system of claim 9, wherein said vacuum source comprises a portable hepa filter vacuum.